Application No. Applicant(s) 09/868,543 KRISKO ET AL. Interview Summary Art Unit **Examiner** Andrew Piziali 1775 All participants (applicant, applicant's representative, PTO personnel): (1) Andrew Piziali _. (3)John Dolan. (2) Deborah Jones. (4) Eric Snustad. Date of Interview: 25 February 2003. Type: a) Telephonic b) Video Conference c) Personal [copy given to: 1) applicant 2) applicant's representative] Exhibit shown or demonstration conducted: d) Yes e)⊠ No. If Yes, brief description: _____. Claim(s) discussed: 1-10. Identification of prior art discussed: USPN 6,165,598. Agreement with respect to the claims f) was reached. g) was not reached. h) N/A. Substance of Interview including description of the general nature of what was agreed to if an agreement was reached, or any other comments: In response to the rejection mailed 10/31/2002 the applicant will consider discussing how the sputtering of the silicon oxide layer makes a significant difference over pyrolytic deposition. Applicant will consider adding claim(s) to the thicknesses of the layers . (A fuller description, if necessary, and a copy of the amendments which the examiner agreed would render the claims allowable, if available, must be attached. Also, where no copy of the amendments that would render the claims allowable is available, a summary thereof must be attached.) i) It is not necessary for applicant to provide a separate record of the substance of the interview (if box is checked). Unless the paragraph above has been checked, THE FORMAL WRITTEN REPLY TO THE LAST OFFICE ACTION MUST INCLUDE THE SUBSTANCE OF THE INTERVIEW. (See MPEP Section 713.04). If a reply to the last Office action has already been filed, APPLICANT IS GIVEN ONE MONTH FROM THIS INTERVIEW DATE TO FILE A STATEMENT OF THE SUBSTANCE OF THE INTERVIEW. See Summary of Record of Interview requirements on reverse side or on attached sheet.

U.S. Patent and Trademark Office PTO-413 (Rev. 03- 98)

Examiner Note: You must sign this form unless it is an

Attachment to a signed Office action.

Interview Summary

Paper No. 14.